

**0.2A SCHOTTKY BARRIER DIODE CHIP SCALE PACKAGE**
**Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (mA)	V <sub>F(MAX)</sub> (V) @ +25°C	I <sub>R(MAX)</sub> (mA) @ +25°C
30	200	0.50	0.05

**Description**

The SDM0230CSP is a 30-volt 0.2A schottky barrier diode that is optimized for low forward voltage drop and low leakage current housed in a compact chip scale package (CSP) that occupies only 0.18mm<sup>2</sup> board-space. The low thermal resistance enables designers to meet design challenges of increasing efficiency whilst at the same time reducing board space. It is ideally suited for use in portable applications.

**Applications**

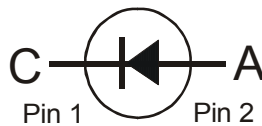
- Blocking Diode
- Switching Diode
- Reverse Protection Diode
- Boost Diode

**Features and Benefits**

- 0.18mm<sup>2</sup> footprint – 70% smaller than DFN1006/SOD923
- Off board profile of 0.3mm – more than 30% thinner than the DFN1006
- Low forward voltage of 0.50V (max) – minimises power dissipation losses
- Low leakage – maximises battery power
- Soft, Fast Switching Capability
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. “Green” Device (Note 3)**

**Mechanical Data**

- Case: X3-WLCUS0603-3
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Dot
- Weight: 0.119mg


**Ordering Information** (Note 4)

Part Number	Case	Packaging
SDM0230CSP-7	X3-WLCUS0603-3	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

**Marking Information**


X7 = Product Type Marking Code  
Dot denotes Cathode Pin

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	30	V
Average Rectified Output Current	$I_O$	0.2	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	4.5	A

**Thermal Characteristics**

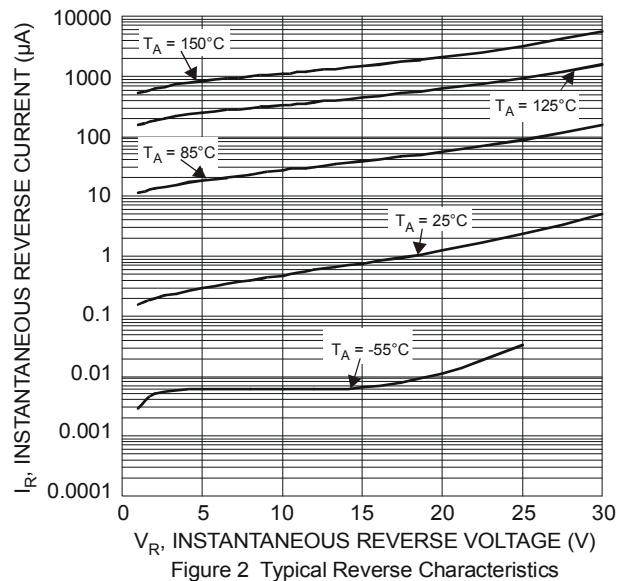
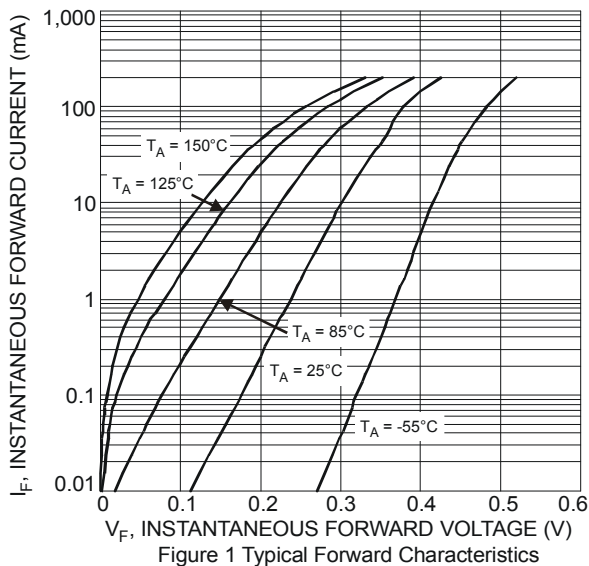
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	261	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	$V_F$	—	0.30	0.35	V	$I_F = 10\text{mA}, T_J = +25^\circ\text{C}$
		—	0.42	0.50		$I_F = 200\text{mA}, T_J = +25^\circ\text{C}$
		—	0.36	—		$I_F = 200\text{mA}, T_J = +125^\circ\text{C}$
Leakage Current (Note 6)	$I_R$	—	—	50	$\mu\text{A}$	$V_R = 30\text{V}, T_J = +25^\circ\text{C}$
		—	1.5	—	$\text{mA}$	$V_R = 30\text{V}, T_J = +125^\circ\text{C}$
Junction Capacitance	$C_J$	—	9	—	$\text{pF}$	$V_R = 15\text{V}, T_J = +25^\circ\text{C}, f = 1\text{MHz}$

Notes: 5. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout per <http://www.diodes.com/datsheets/ap02001.pdf>.  
6. Short duration pulse test used to minimize self-heating effect.

**Typical Electrical Characteristics**



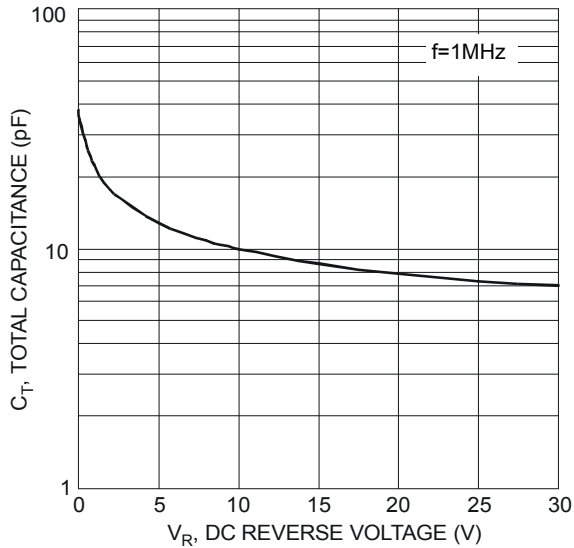
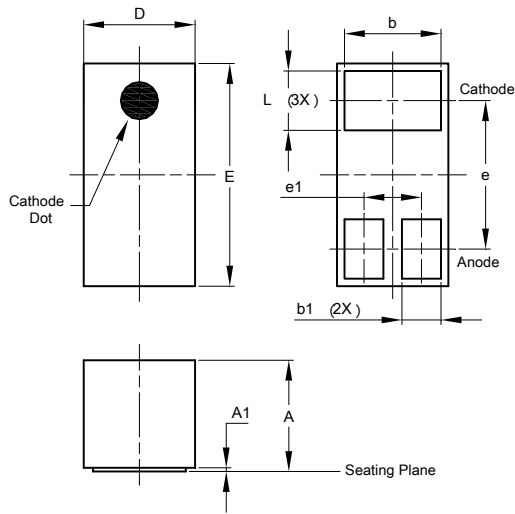


Figure 3 Total Capacitance vs. Reverse Voltage

### Package Outline Dimensions

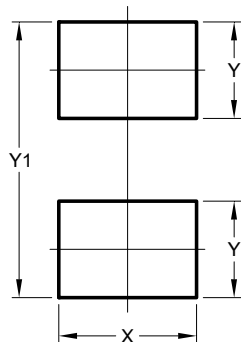
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



X3-WLCUS0603-3			
Dim	Min	Max	Typ
A	0.24	0.30	—
A1	0.00	0.01	—
b	0.23	0.29	0.26
b1	0.075	0.135	0.105
D	0.290	0.300	0.295
E	0.590	0.600	0.595
e	—	—	0.40
e1	—	—	0.155
L	0.13	0.19	0.16
All Dimensions in mm			

### Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X	0.30
Y	0.21
Y1	0.60

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